

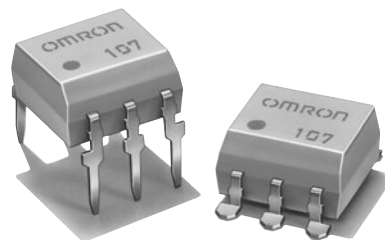
G3VM-41BR/ER

MOS FET Relays

Higher power, 3.5-A switching with a 40-V load voltage, DIP package.

Low 30 mΩ ON Resistance.

- Continuous load current of 3.5 A. (Connection C: 7 A)
- Switches minute analog signals.
- Dielectric strength of 2,500 Vrms between I/O.



NEW

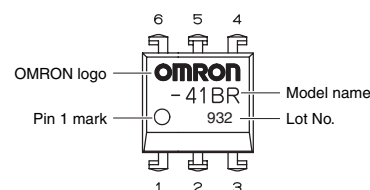
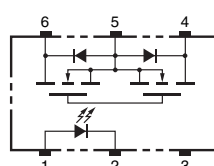
Note: The actual product is marked differently from the image shown here.

RoHS compliant

Application Examples

- Communication equipment
- Test & Measurement equipment
- Security equipment
- Factory Automation equipment
- Power circuit

Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity	
					Number per stick	Number per tape and reel
DIP6	1a (SPST-NO)	PCB terminals	40 V	G3VM-41BR	50	---
		Surface-mounting terminals		G3VM-41ER		
				G3VM-41ER (TR)	---	1,500

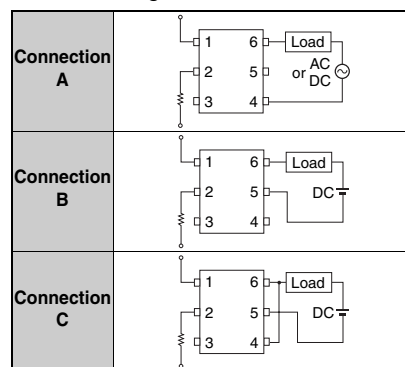
* The AC peak and DC value are given for the load voltage.

Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Rating	Unit	Measurement conditions
Input	LED forward current	IF	30	mA	
	Repetitive peak LED forward current	IFP	1	A	100 μs pulses, 100 pps
	LED forward current reduction rate	ΔIF/°C	-0.3	mA/°C	Ta ≥ 25°C
	LED reverse voltage	VR	5	V	
	Connection temperature	TJ	125	°C	
Output	Load voltage (AC peak/DC)	V _{OFF}	40	V	
	Continuous load current	Io	3.5	A	Connection A: AC peak/DC Connection B and C: DC
			3.5		
			7		
	ON current reduction rate	ΔIo/°C	-35	mA/°C	Ta ≥ 25°C
			-35		
			-70		
	Pulse ON current	I _{OP}	10.5	A	t = 100 ms, Duty = 1/10
	Connection temperature	TJ	125	°C	
Dielectric strength between I/O (See note 1.)		V _{I-O}	2500	Vrms	AC for 1 min
Operating temperature		Ta	-40 to +85	°C	With no icing or condensation
Storage temperature		T _{stg}	-55 to +125	°C	With no icing or condensation
Soldering temperature		---	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

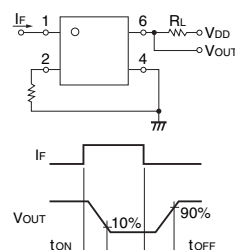
Connection Diagram



Electrical Characteristics (Ta = 25°C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	V _F	1.18	1.33	1.48	V	I _F = 10 mA
	Reverse current	I _R	---	---	10	μA	V _R = 5 V
	Capacity between terminals	C _T	---	70	---	pF	V = 0, f = 1 MHz
	Trigger LED forward current	I _{FT}	---	0.5	3	mA	I _o = 1 A
Output	Maximum resistance with output ON	R _{ON}	---	30	60	mΩ	I _F = 5 mA, I _o = 2 A, t < 1 s
			---	15	---	mΩ	I _F = 5 mA, I _o = 2 A, t < 1 s
			---	8	---	mΩ	I _F = 5 mA, I _o = 4 A, t < 1 s
	Current leakage when the relay is open	I _{LEAK}	---	---	1.0	μA	V _{OFF} = 40 V
	Capacity between terminals	C _{OFF}	---	1000	---	pF	V = 0, f = 1 MHz
Capacity between I/O terminals		C _{I-O}	---	0.8	---	pF	f = 1 MHz, V _s = 0 V
Insulation resistance between I/O terminals		R _{I-O}	1000	---	---	MΩ	V _{I-O} = 500 VDC, R _{oH} ≤ 60%
Turn-ON time		t _{ON}	---	2	5	ms	I _F = 5 mA, R _L = 200 Ω, V _{DD} = 20 V (See note 2.)
Turn-OFF time		t _{OFF}	---	0.1	1	ms	

Note: 2. Turn-ON and Turn-OFF Times



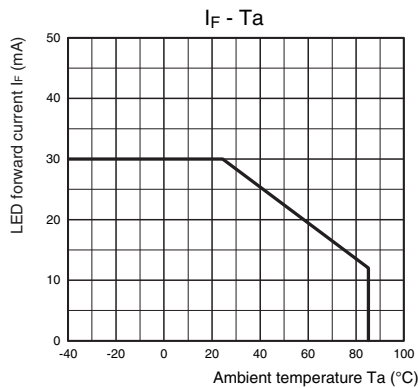
Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

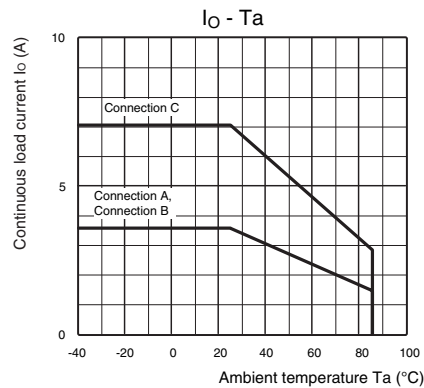
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V_{DD}	---	---	32	V
Operating LED forward current	I_F	5	10	25	mA
Continuous load current (AC peak/DC)	I_O	---	---	3.5	A
Operating temperature	T_a	-20	---	65	°C

Engineering Data

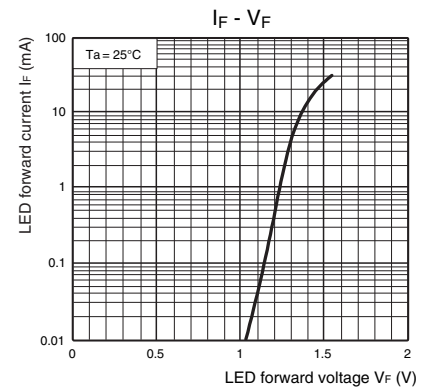
LED forward current vs.
Ambient temperature



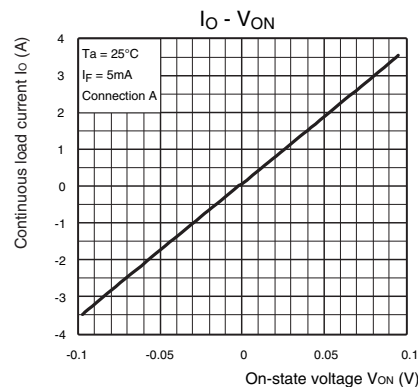
Continuous load current vs.
Ambient temperature



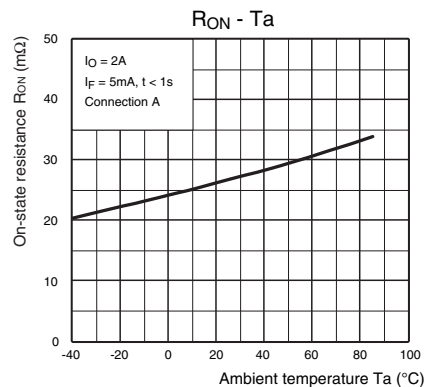
LED forward current vs.
LED forward voltage



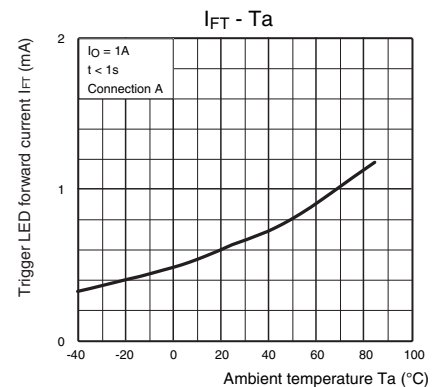
Continuous load current vs.
On-state voltage



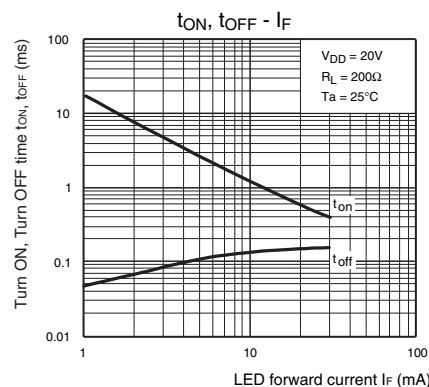
On-state resistance vs.
Ambient temperature



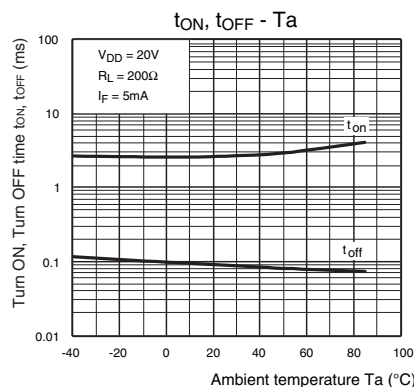
Trigger LED forward current vs.
Ambient temperature



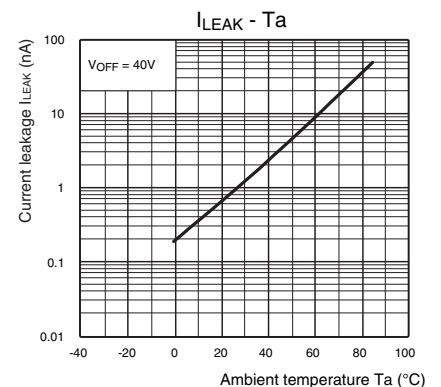
Turn ON, Turn OFF time vs.
LED forward current



Turn ON, Turn OFF time vs.
Ambient temperature



Current leakage vs.
Ambient temperature

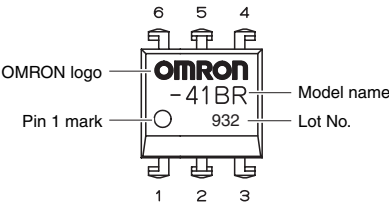


Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

■ Appearance

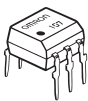
DIP (Dual Inline Package)
DIP6



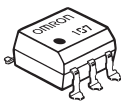
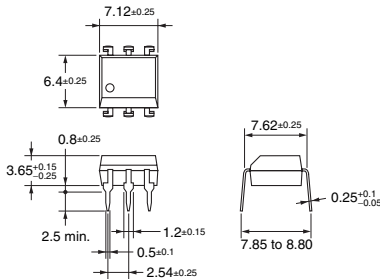
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■ Dimensions

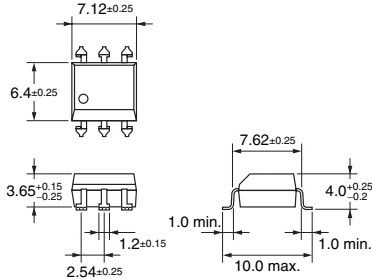
(Unit: mm)



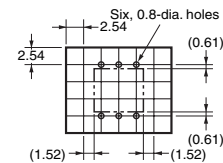
PCB Terminals
Weight: 0.4 g



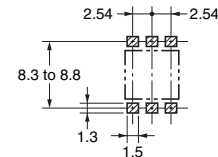
Surface-mounting Terminals
Weight: 0.4 g



PCB Dimensions (Bottom View)



Actual Mounting Pad Dimensions
(Recommended Value, Top View)



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• Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
• Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

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На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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